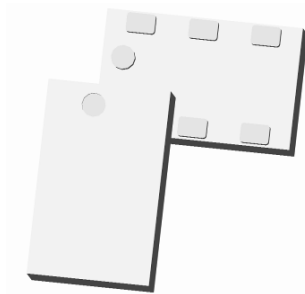




**Ultra Low Profile 0805  
10dB Directional Coupler**



**Description:**

The DC1722J5010AHF is a low cost, low profile sub-miniature high performance 10 dB directional coupler in an easy to use RoHS compliant, Halogen Free surface mount package. It is designed for 1700 – 2200MHz applications including: LTE, WCDMA, CDMA, IMT2000, UMTS and GSM1800 / 1900 applications. The DC1722J5010AHF is ideal for power detection, signal injection and other applications where low insertion loss signal monitoring is required. The DC1722J5010AHF is available on tape and reel for pick and place high volume manufacturing. All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability. All parts have been subjected to rigorous qualification testing and units are 100% RF tested.

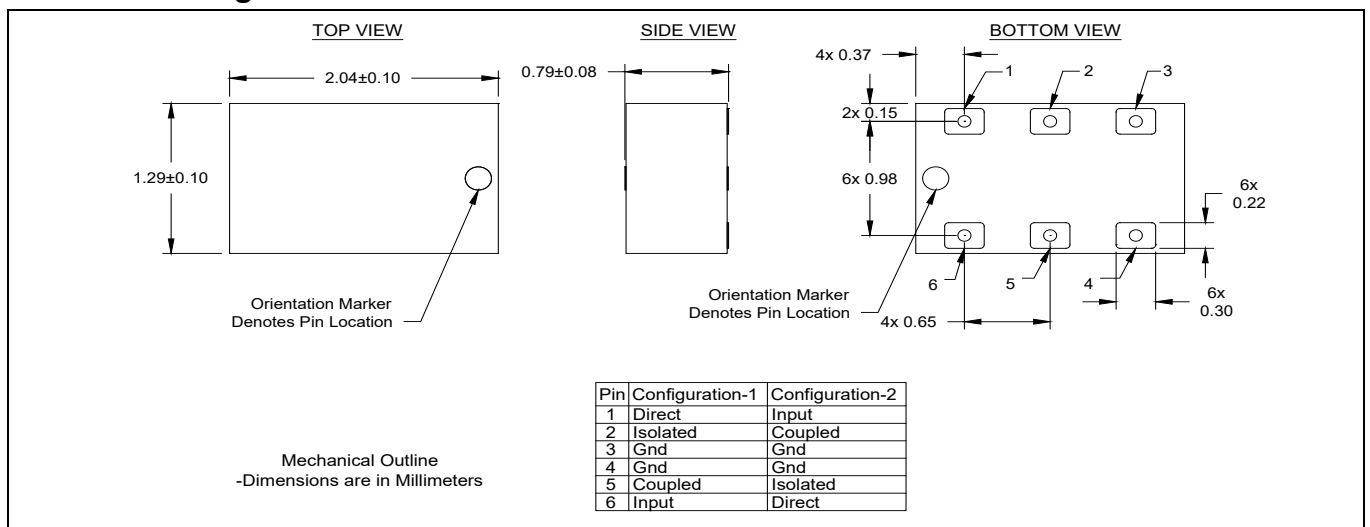
**Detailed Electrical Specifications:**

Features:	ROOM (25°C)													
	Frequency (MHz)	Mean Coupling (dB)			Insertion loss (dB)		Return Loss (dB)		Directivity (dB)		Frequency Sensitivity (dB)		Power Handling (watts)	
		Min	Typ.	Max	Typ.	Max	Typ.	Min	Typ.	Min	Typ.	Max	Max @85C	Max @105C
<ul style="list-style-type: none"> <li>• 1700 – 2200 MHz</li> <li>• Mean Coupling 10dB</li> <li>• 0.79mm Height Profile</li> <li>• Ultra Low Insertion Loss</li> <li>• LTE Bands: 1,2,3,4,9,10,33,34,35,36,37,39</li> <li>• WCDMA, CDMA, IMT2000, UMTS, GSM 1800/1900</li> <li>• Surface Mountable</li> <li>• Tape &amp; Reel</li> <li>• RoHS Compliant</li> <li>• Halogen Free</li> <li>• 100% RF Tested</li> <li>• -55°C to 140°C</li> </ul>	1700 - 2200	9.9	10.6	11.2	0.13	0.30	19.0	15.6	16.6	13.1	0.23	0.25	2	1.3
	1805 - 1880	9.8	10.5	11.0	0.14	0.30	19.0	15.9	23.2	18.2	0.01	0.04	2	1.3
	1930 - 1990	9.8	10.5	11.1	0.15	0.30	19.0	16.1	20.7	16.4	0.02	0.03	2	1.3
	2110 - 2170	10.0	10.7	11.4	0.16	0.31	20.0	16.5	17.2	13.6	0.07	0.10	2	1.3
	Group Delay (1.7-2.2GHz) (nSec)	Direct Min.			Direct Typ.		Direct Max.		Coupled Min.		Coupled Typ.		Coupled Max.	
	0.048			0.052		0.056		0.175		0.184		0.192		

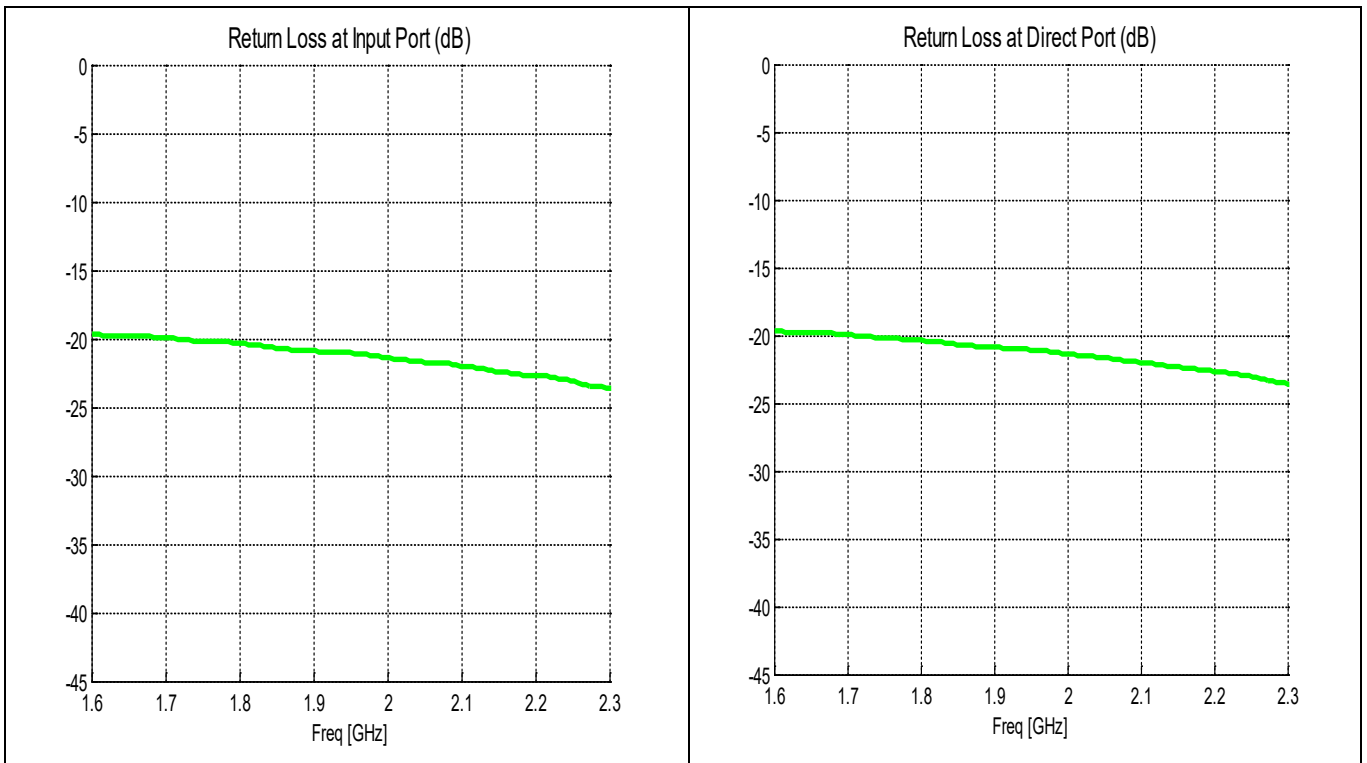
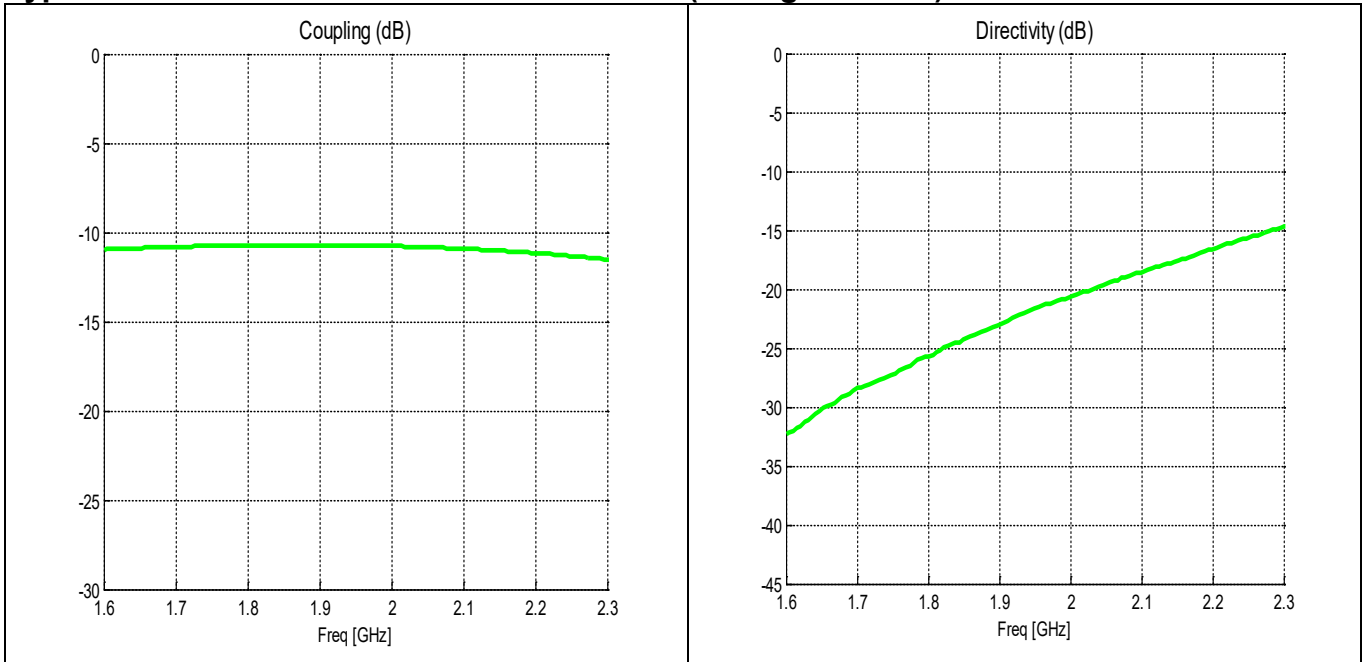
\*Specifications subject to change without notice.

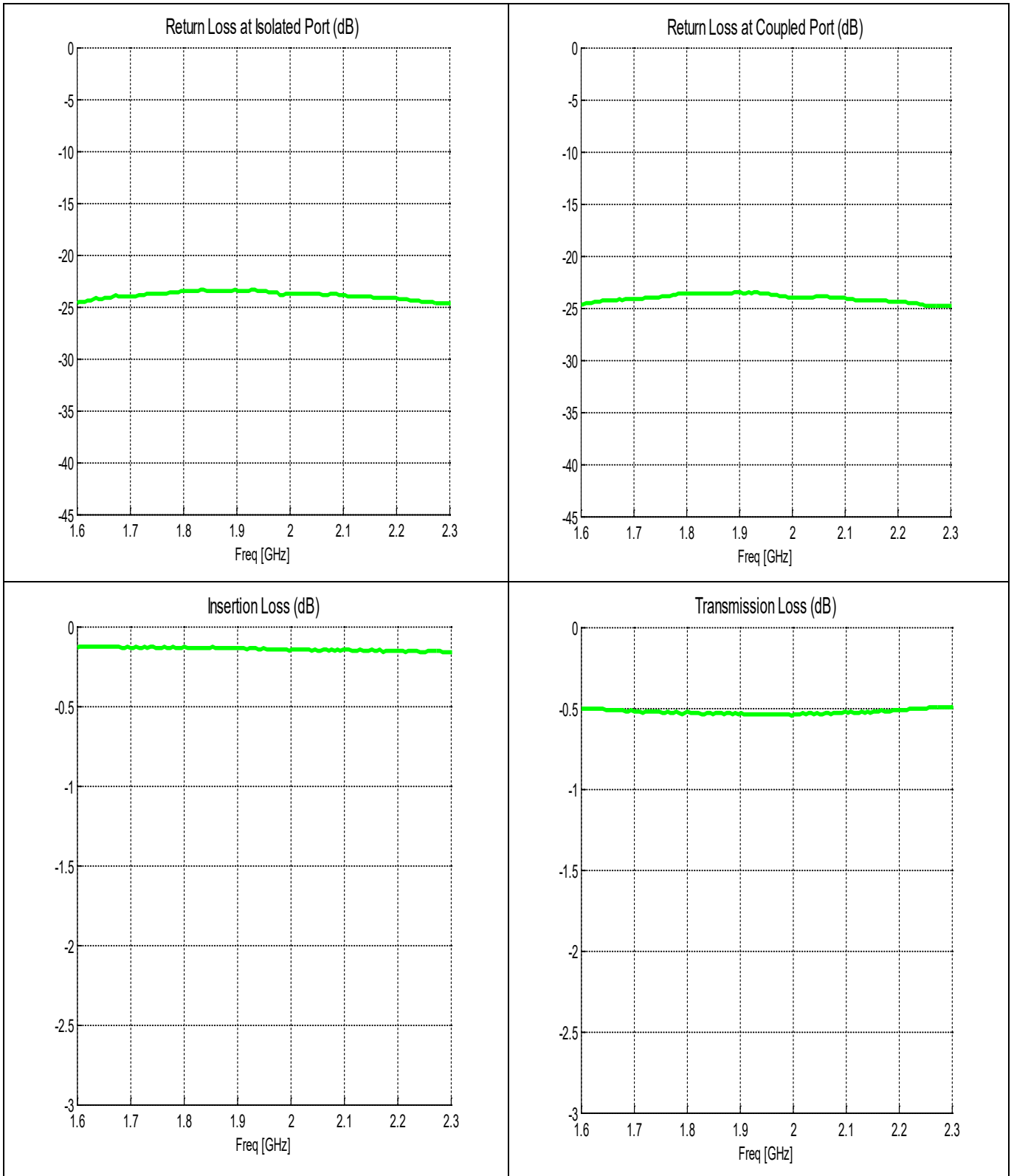
\*\*Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance.

**Outline Drawing:**

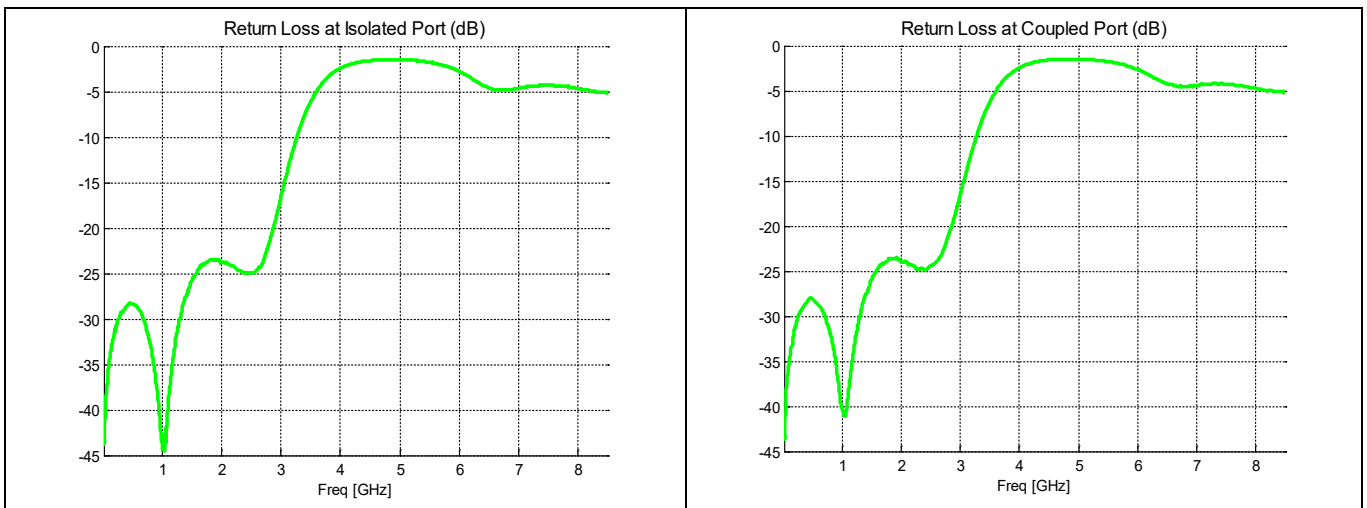
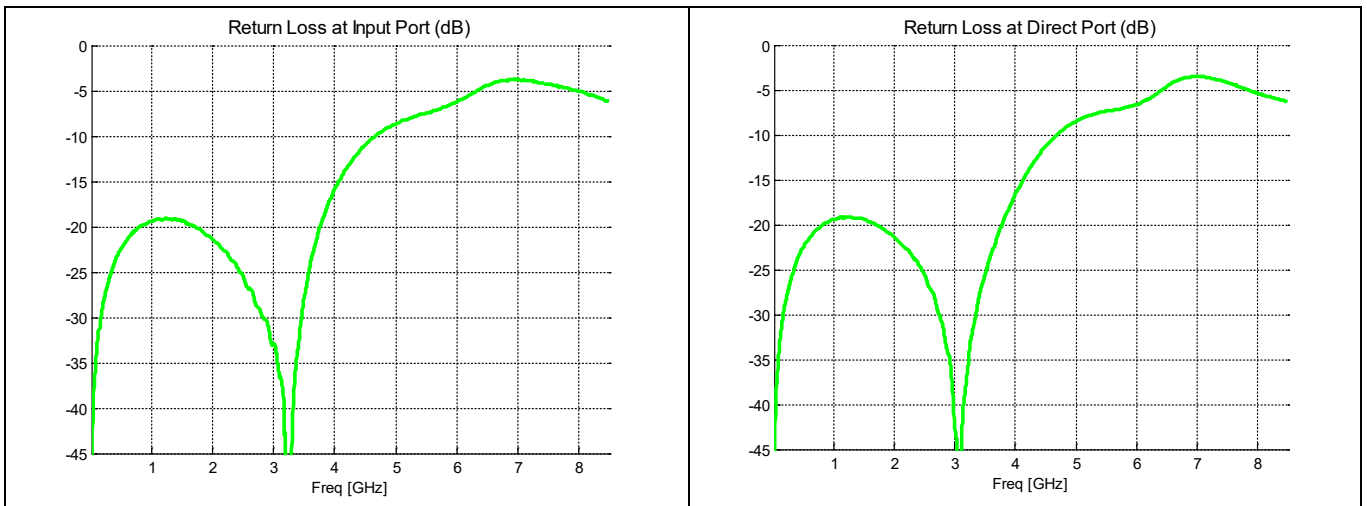
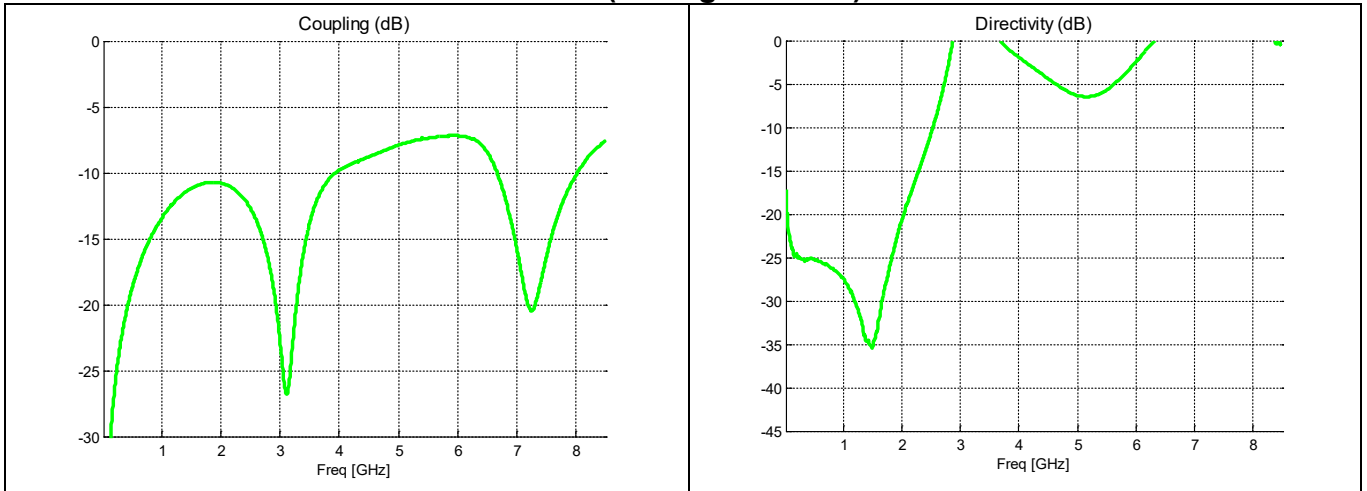


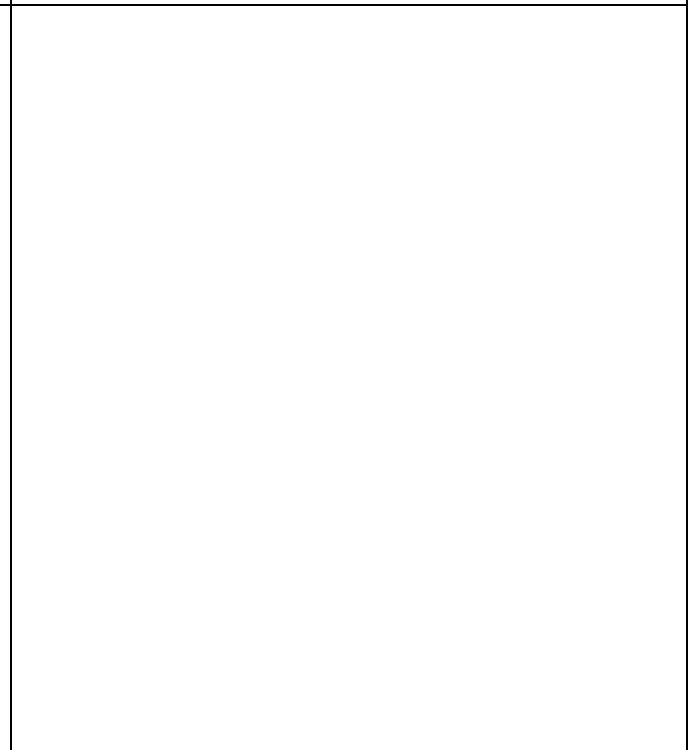
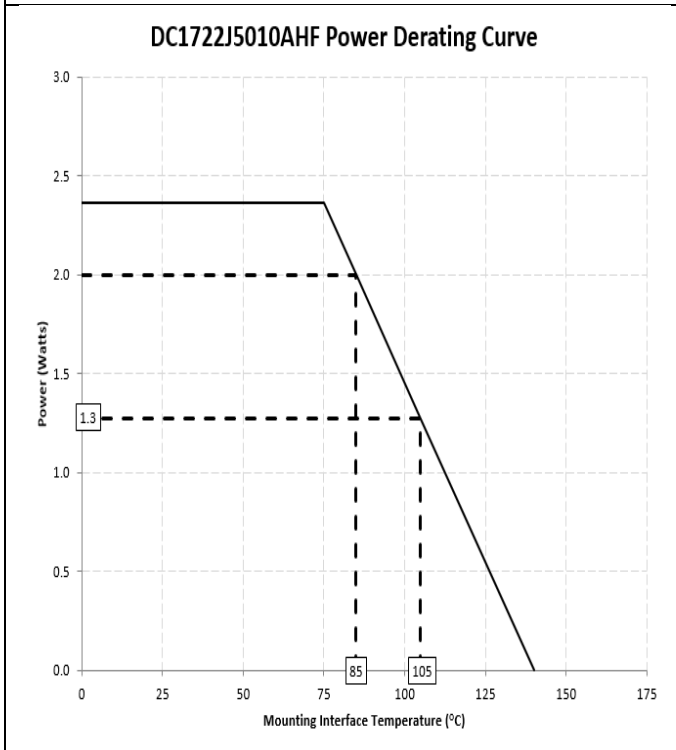
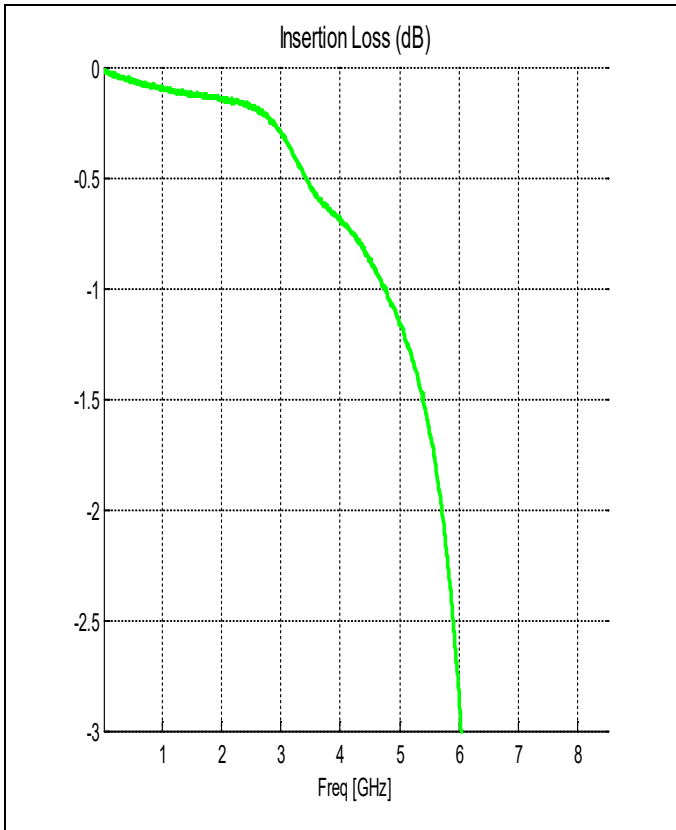
**Typical Performance: 1600 MHz to 2300 MHz (Configuration 1)**





**Wide Band Performance: 0 to 8500MHz (Configuration 1)**





## Definition of Measured Specifications

Parameter	Definition	Mathematical Representation
<b>Return Loss</b>	The impedance match of the coupler to a 50Ω system. Return Loss is an alternate means to express VSWR.	$\text{Return Loss(dB)} = 20\log \frac{\text{VSWR} + 1}{\text{VSWR} - 1}$
<b>Directivity</b>	The power at the isolated port divided by the power at the coupled port	$\text{Directivity(dB)} = 10\log \frac{P_{\text{iso}}}{P_{\text{cpl}}}$
<b>Insertion Loss</b>	The input power divided by the sum of the power at the two output ports.	$\text{Insertion Loss(dB)} = 10\log \frac{P_{\text{in}}}{P_{\text{cpl}} + P_{\text{direct}}}$
<b>Mean Coupling</b>	At a given frequency ( $\omega_n$ ), coupling is the input power divided by the power at the coupled port.  Mean coupling is the average value of the coupling values in the band. N is the number of frequencies in the band.	$\text{Coupling(dB)} = C(\omega_n) = 10\log \frac{P_{\text{in}}(\omega_n)}{P_{\text{cpl}}(\omega_n)}$ $\text{Mean Coupling(dB)} = \frac{\sum_{n=1}^N C(\omega_n)}{N}$
<b>Transmission Loss</b>	The input power divided by the power at the direct port	$\text{Transmission Loss(dB)} = 10\log \frac{P_{\text{in}}}{P_{\text{direct}}}$
<b>Frequency sensitivity</b>	The decibel difference between the maximum in band coupling value and the minimum in band coupling value.	$(\text{Max Coupling (dB)} - \text{Min Coupling (dB)})/2$

\*100% RF test is performed on configuration 1 where port 1 is connected to pin 1, port 2 is connected to pin 2, port 3 is connected to pin 5 and port 4 is connected to pin 6.

## Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.

